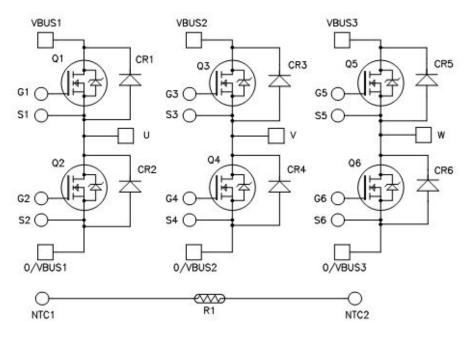
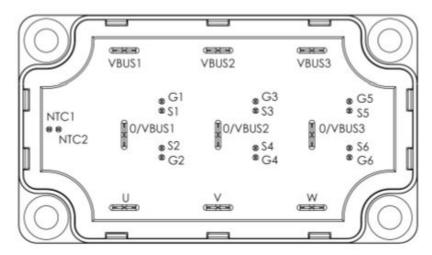
MSCSM170TAM15CTPAG

Triple Phase Leg SiC MOSFET Power Module

Product Overview

The MSCSM170TAM15CTPAG device is a triple phase leg 1700 V, 179 A silicon carbide (SiC) MOSFET power module.





All ratings at T_J = 25 °C, unless otherwise specified.

Caution: These devices are sensitive to electrostatic discharge. Proper handling procedures must be followed.

Features

The following are key features of the MSCSM170TAM15CTPAG device:

- · SiC Power MOSFET
 - Low R_{DS(on)}
 - High temperature performance
- SiC Schottky Diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature independent switching behavior
 - Positive temperature coefficient on VF
- · Very low stray inductance
- · Internal thermistor for temperature monitoring
- Aluminum nitride (AIN) substrate for improved thermal performance

Benefits

The following are the benefits of MSCSM170TAM15CTPAG device:

- · High power and efficiency converters and inverters
- · Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- · Low junction-to-case thermal resistance
- · Solderable terminals for power and signal for easy mounting of PCB
- · Low profile
- RoHS compliant

Application

The MSCSM170TAM15CTPAG device is designed for the following applications:

- · Welding converters
- · Switched mode power supplies
- · Uninterruptible power supplies
- · EV motor and traction drive

1. Electrical Specifications

This section provides the electrical specifications of the MSCSM170TAM15CTPAG device.

1.1 SiC MOSFET Characteristics (Per SiC MOSFET)

The following table lists the absolute maximum ratings per SiC MOSFET of the MSCSM170TAM15CTPAG device.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter		Maximum Ratings	Unit
V _{DSS}	Drain-Source voltage		1700	V
I _D	Continuous drain current	T _C = 25 °C	179	Α
		T _C = 80 °C	142	
I _{DM}	Pulsed drain current		360	
V _{GS}	Gate-Source voltage		-10/23	V
R _{DS(on)}	Drain-Source ON resistance		15	mΩ
P _D	Power dissipation	T _C = 25 °C	843	W

The following table lists the electrical characteristics per SiC MOSFET of the MSCSM170TAM15CTPAG device.

Table 1-2. Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V; V _{DS} = 1700 V		_	30	300	μΑ
R _{DS(on)}	Drain-Source on	V _{GS} = 20 V	T _J = 25 °C	_	11.7	15	mΩ
	resistance	I _D = 90 A	T _J = 175 °C	_	20.8	_	
V _{GS(th)}	Gate threshold voltage	$V_{GS} = V_{DS}; I_D = 7.5 \text{ mA}$		1.8	3.2	_	V
I _{GSS}	Gate–Source leakage current	V _{GS} = 20 V; V _{DS} = 0 V		_	_	300	nA

The following table lists the dynamic characteristics per SiC MOSFET of the MSCSM170TAM15CTPAG device.

Table 1-3. Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
C _{iss}	Input capacitance	V _{GS} = 0 V		_	9900	_	pF
C _{oss}	Output capacitance	V _{DS} = 1000 V		_	450	_	
C _{rss}	Reverse transfer capacitance	f = 1 MHz		_	30	_	
Q_g	Total gate charge	V _{GS} = -5 V/20 V		_	534	_	nC
Q _{gs}	Gate-Source charge	V _{Bus} = 850 V		_	147	_	
Q_{gd}	Gate-Drain charge	I _D = 90 A		_	81	_	
T _{d(on)}	Turn-on delay time	T _J = 150 °C		_	24	_	ns
T _r	Rise time	$V_{GS} = -5 \text{ V}/20 \text{ V}$		_	17	_	
T _{d(off)}	Turn-off delay time	V _{Bus} = 900 V		_	35	_	
T _f	Fall time	$I_D = 150 \text{ A}$ $R_{G(on)} = 1.6 \Omega$ $R_{G(off)} = 0.9 \Omega$			19	_	
E _{on}	Turn-on energy	V _{GS} = -5 V/20 V	T _J = 150 °C	_	3.3	_	mJ
E _{off}	Turn-off energy	$V_{Bus} = 900 \text{ V}$ $I_D = 150 \text{ A}$ $R_{G(on)} = 1.6 \Omega$ $R_{G(off)} = 0.9 \Omega$	T _J = 150 °C	_	0.5	_	
R _{Gint}	Internal gate resistance	te resistance		_	1.95	_	Ω
R _{thJC}	Junction-to-case therm	nal resistance			_	0.178	°C/W

The following table lists the body diode ratings and characteristics per SiC MOSFET of the MSCSM170TAM15CTPAG device.

Table 1-4. Body Diode Ratings and Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V _{SD}	Diode forward voltage	V _{GS} = 0 V; I _{SD} = 90 A	_	3.7	_	٧
		$V_{GS} = -5 \text{ V}; I_{SD} = 90 \text{ A}$	_	3.9	_	
t _{rr}	Reverse recovery time	I _{SD} = 90 A; V _{GS} = -5 V	_	27	_	ns
Q _{rr}	Reverse recovery charge	$V_R = 900 \text{ V}; \text{ di}_F/\text{dt} = 3000 \text{ A/µs}$	_	1950	_	nC
I _{rr}	Reverse recovery current		_	138	_	Α

1.2 SiC Schottky Diode Ratings and Characteristics (Per SiC Diode)

The following table lists the SiC diode ratings and characteristics per SiC diode of MSCSM170TAM15CTPAG device.

Table 1-5. SiC Schottky Diode Ratings and Characteristics

Symbol	Characteristic	Test Conditions	Test Conditions		Тур	Max	Unit
V _{RRM}	Peak repetitive reverse volt	age		_	_	1700	V
I _{RRM}	Reverse leakage current	V _R = 1700 V	T _J = 25 °C	_	10	200	μA
			T _J = 175 °C	_	150	_	
I _F	DC forward current	_	T _C = 125 °C	_	30	_	Α
V _F	Diode forward voltage	I _F = 30 A	T _J = 25 °C	_	1.5	1.8	V
			T _J = 175 °C	_	2.3	_	
Q _C	Total capacitive charge	V _R = 900 V		_	230	_	nC
С	Total capacitance	f = 1 MHz, V _R = 600 V		_	167	_	pF
		f = 1 MHz, V _R = 900 V		_	138	_	
R _{thJC}	Junction-to-case thermal re	sistance		_	_	0.532	°C/W

1.3 Thermal and Package Characteristics

The following table lists the thermal and package characteristics of the MSCSM170TAM15CTPAG device.

Table 1-6. Thermal and Package Characteristics

Symbol	Characteristics			Min	Max	Unit
V _{ISOL}	RMS isolation voltage, any terminal to c	ase t =1 min, 5	50 Hz/60 Hz	4000	_	٧
T _J	Operating junction temperature range			-40	175	°C
T _{JOP}	Recommended junction temperature under switching conditions			-40	T _{Jmax} –25	
T _{STG}	Storage temperature range			-40	125	
T _C	Operating case temperature			-40	125	
Torque	Mounting torque	To heatsink	M6	3	5	N.m
Wt	Package weight	Package weight			250	g

The following table lists the temperature sensor NTC of the MSCSM170TAM15CTPAG device.

Table 1-7. Temperature Sensor NTC

Symbol	Characteristic		Min	Тур	Max	Unit
R ₂₅	Resistance at 25 °C		_	50	_	kΩ
$\Delta R_{25}/R_{25}$	_	_	_	5	_	%
B _{25/85}	T ₂₅ = 298.15 K	_	_	3952	_	K
ΔΒ/Β	_	T _C = 100 °C	_	4	_	%

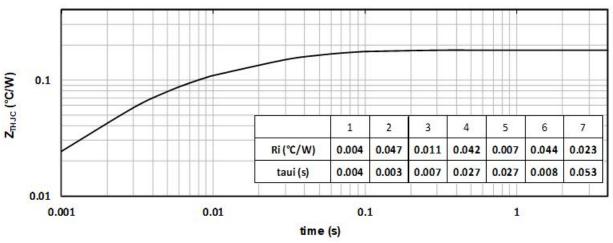
$$R_{T} = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$
 T: Thermistor temperature R_T: Thermistor value at T

Note: See APT0406—Using NTC Temperature Sensor Integrated into Power Module for more information.

Typical SiC MOSFET Performance Curve 1.4

This section shows the typical SiC MOSFET performance curves of the MSCSM170TAM15CTPAG device.

Figure 1-1. Maximum Thermal Impedance



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Figure 1-2. Output Characteristics, T_J = 25 °C

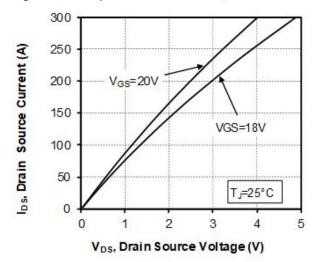


Figure 1-3. Output Characteristics, T_J = 175 °C

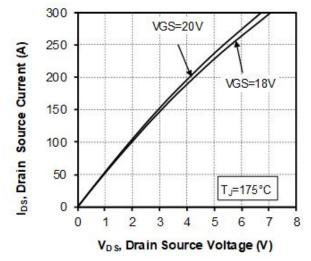


Figure 1-4. Normalized R_{DS(on)} vs. Temperature

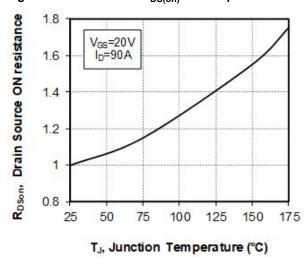


Figure 1-5. Transfer Characteristics

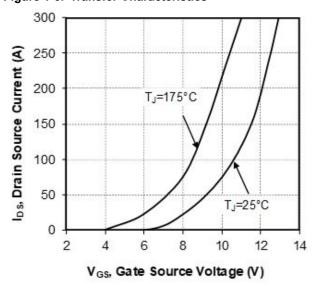


Figure 1-6. Switching Energy vs. Rg

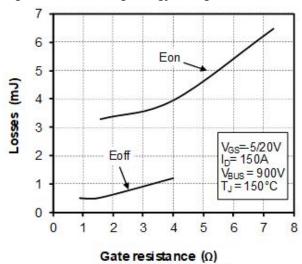


Figure 1-7. Switching Energy vs. Current

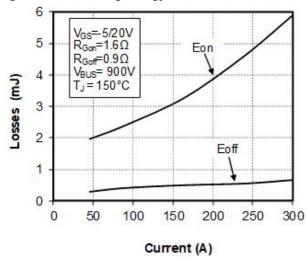


Figure 1-8. Capacitance vs. Drain Source Voltage

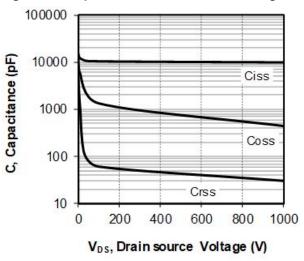
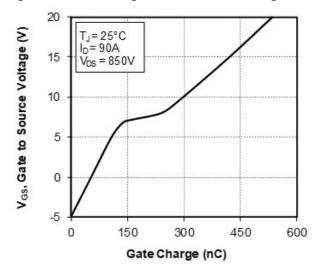


Figure 1-9. Gate Charge vs. Gate Source Voltage



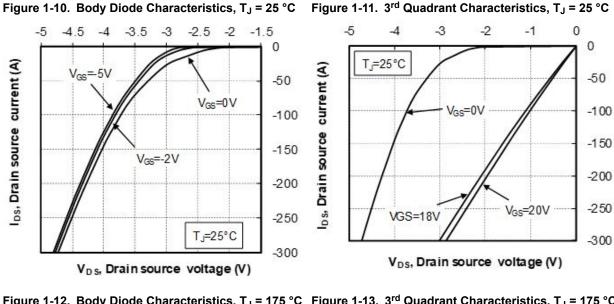
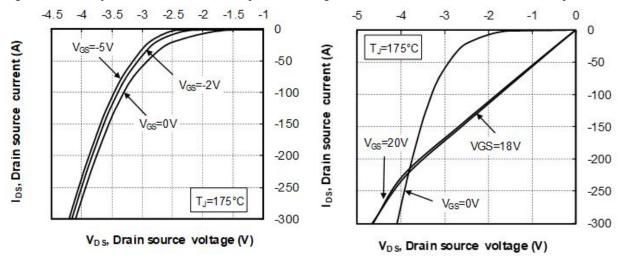


Figure 1-12. Body Diode Characteristics, T_J = 175 °C Figure 1-13. 3^{rd} Quadrant Characteristics, T_J = 175 °C



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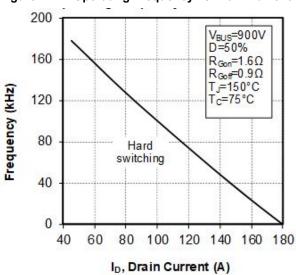


Figure 1-14. Operating Frequency vs Drain Current

1.5 Typical SiC Diode Performance Curves

This section shows the typical SiC diode performance curves of the MSCSM170TAM15CTPAG device.



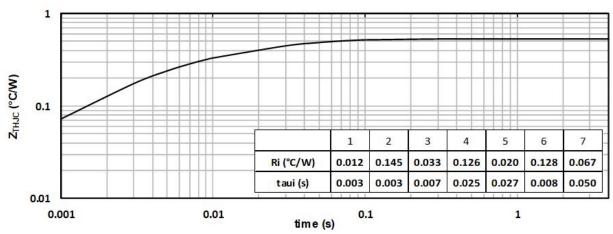


Figure 1-16. Forward Characteristics

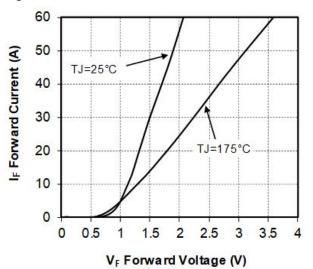
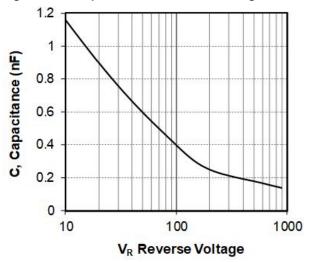


Figure 1-17. Capacitance vs. Reverse Voltage



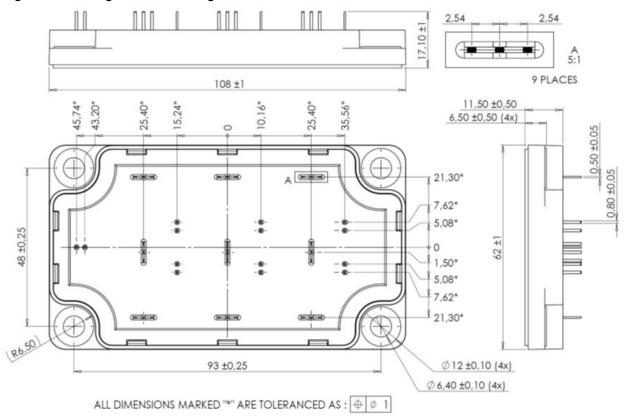
2. Package Specifications

The following section shows the package specification of the MSCSM170TAM23CTPAG device.

2.1 Package Outline

The following figure shows the package outline drawing of the MSCSM170TAM15CTPAG device. The dimensions in the following figure are in millimeters.

Figure 2-1. Package Outline Drawing



Note: See AN1902—Mounting Instruction for SP6–P (12 mm) Power Modules for more information.

MSCSM170TAM15CTPAG

Revision History

3. Revision History

Revision	Date	Description
Α	04/2021	This is the first publication of this document.

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